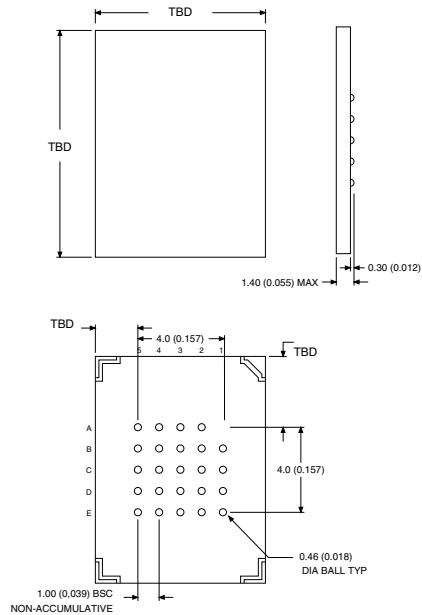


Packaging Information

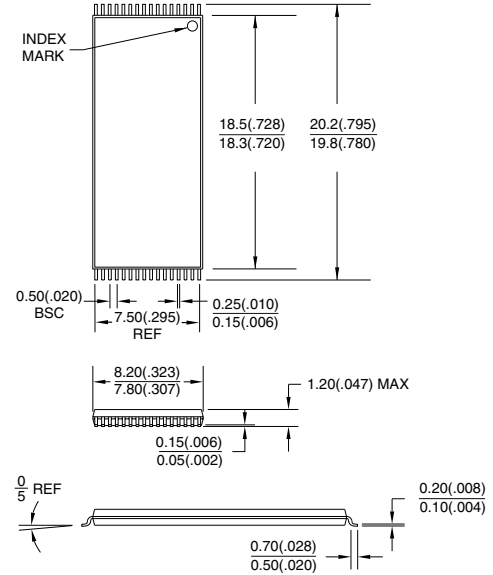
24C3, 24-ball (5 x 5 Array), 1.0 mm Pitch,
Plastic Chip-scale Ball Grid Array (CBGA)
Dimensions in Millimeters and (Inches)*



*Controlling dimension: millimeters

32T, 32-lead, Plastic Thin Small Outline Package (TSOP)

Dimensions in Millimeters and (Inches)*
JEDEC OUTLINE MO-142 BD



*Controlling dimension: millimeters